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| <p>Form PTO-1449 (modified) List of Patents and Publications For Application Information Disclosure Statement (Use several sheets if necessary)</p> | <p>ATTY. DKT. NO. 5732-00100</p> <p>APPLICANT: Chhor et al.</p> <p>FILING DATE: August 13, 2001</p> | <p>SERIAL NO. 09/928,767</p> <p>GROUP: 2818</p> |
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| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | A5 | 4,535,424 | 8/1985 | Reid | | | |
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| | A26 | 5,481,133 | 1/1996 | Hsu | | | |
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the patent owner.

| Form PTO-1449 (modified) List of Patents and Publications For Applicant's Information Disclosure Statement (Use several sheets if necessary) | | | ATTY. DKT. NO. 5732-00100 APPLICANT: Chhor et al. FILING DATE: August 13, 2001 | | | SERIAL NO. 09/928,767 GROUP: 2818 | |
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| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| LT | A75 | 0 073 486 | 3/1983 | EP | | | |
| LT | A76 | 0 387 834 | 9/1990 | EP | | | |

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| LT | A77 | 0 395 886 | 11/1990 | EP | | | |
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Form PTO-1449 (modified)
List of Patents and Publications
For Applicant's Information
Disclosure Statement
(Use several sheets if necessary)

ATTY. DKT. NO. 5732-00300

APPLICANT: Verma et al.

FILING DATE: February 19, 2002

SERIAL NO. 10/080,036

GROUP: 2185

U.S. PATENT DOCUMENTS

| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | B2 | 5,221,642 | 6/1993 | Burns | | | |
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| | B24 | 5,566,051 | 10/1996 | Burns | | | |
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| | B26 | 5,581,121 | 12/1996 | Burns et al. | | | |
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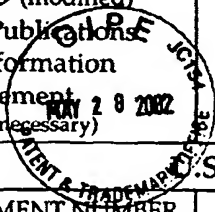
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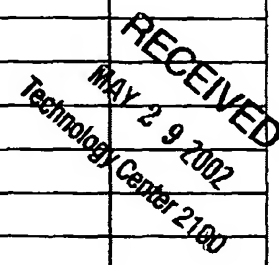
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